

FIG. 1

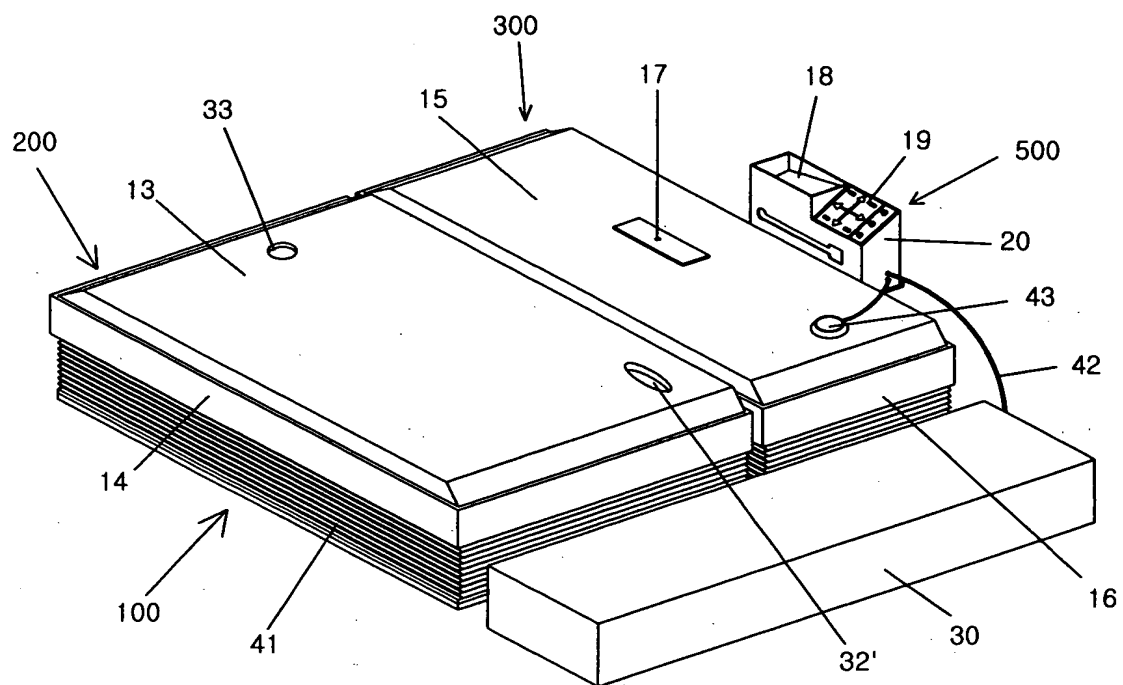


Figure 1 is an exploded perspective view of a multi-layered electronic assembly. The assembly includes a top layer 100' with a base 13, a middle layer 14, and a bottom layer 16. A central component 300 is shown above the middle layer. A connector 18 is attached to the top layer. A grid of components 11 is shown below the middle layer. A detailed view (A) shows a component 21 with a grid of contacts 42. A detailed view (B) shows a component 400 with a grid of contacts 4. Various other components are labeled with numbers 1 through 20.

(A)

FIG.3

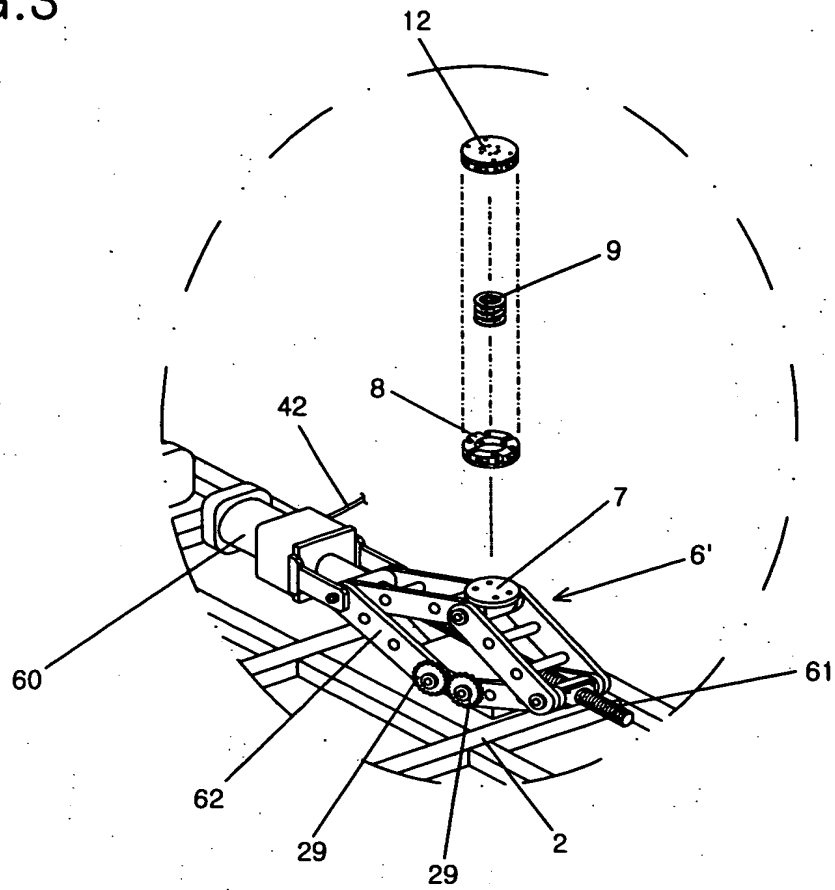


FIG.4

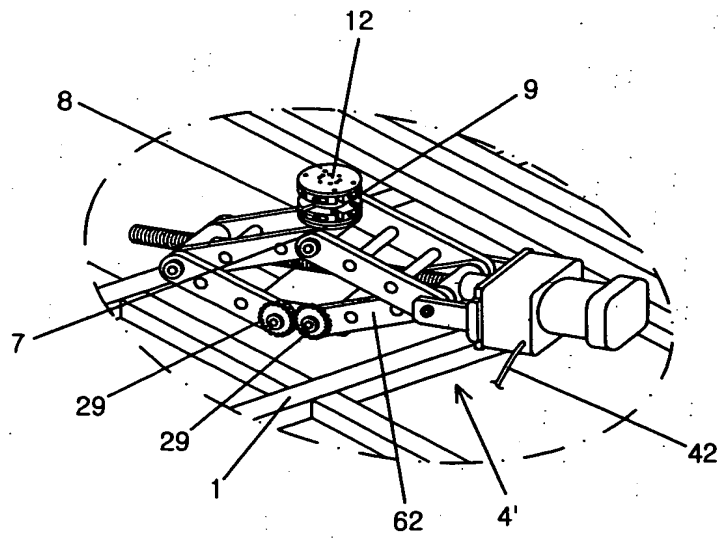


FIG.5

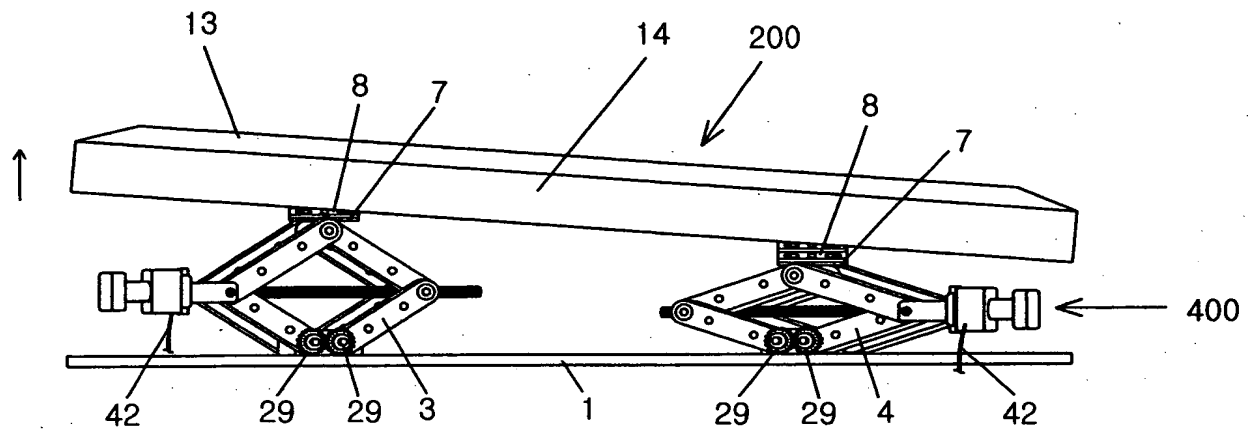


FIG.6

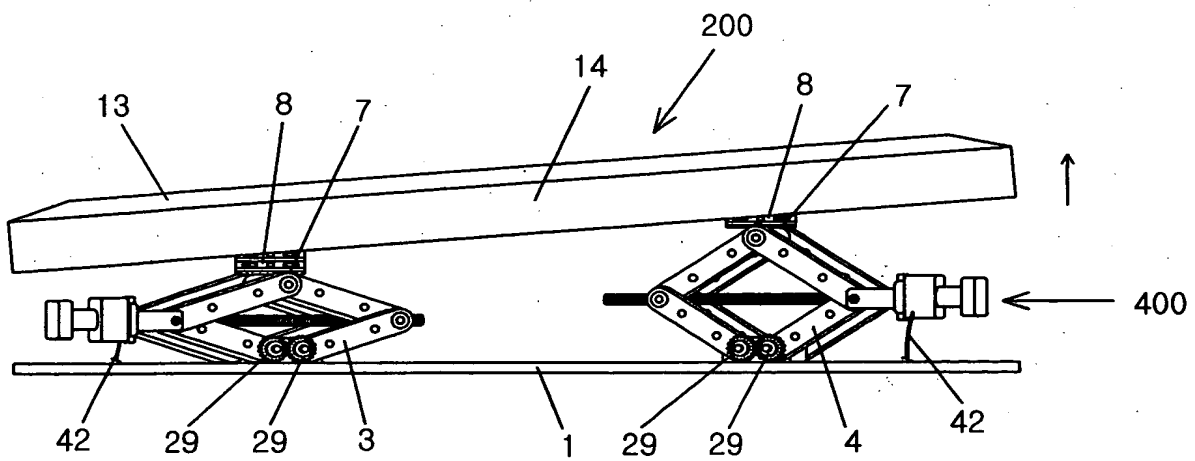


FIG.7

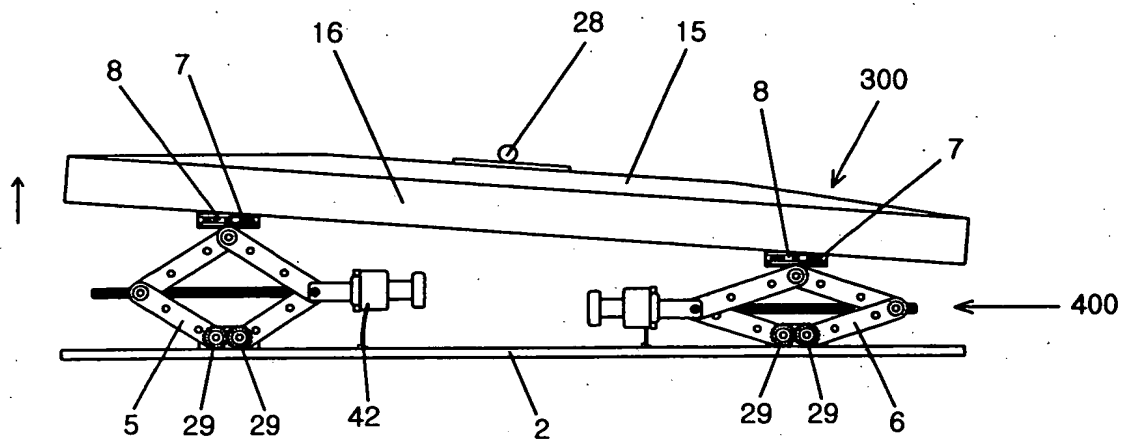


FIG.8

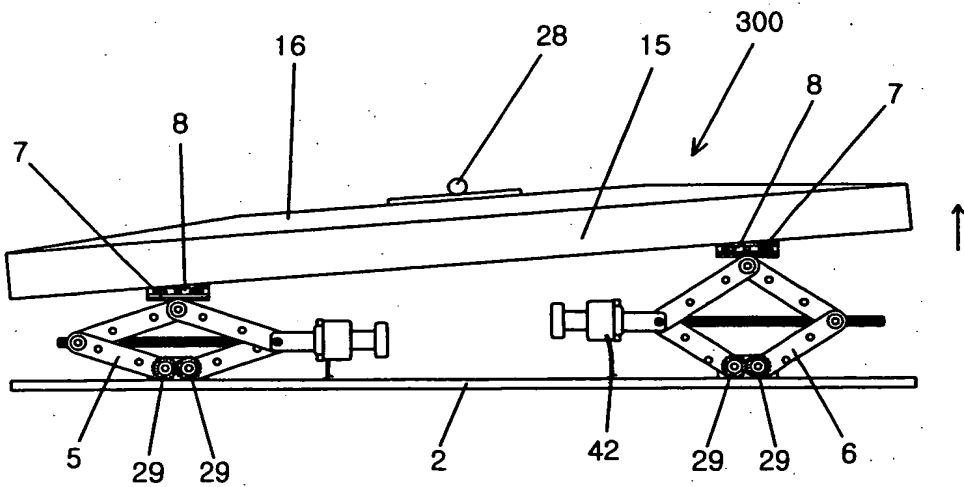


FIG.9a

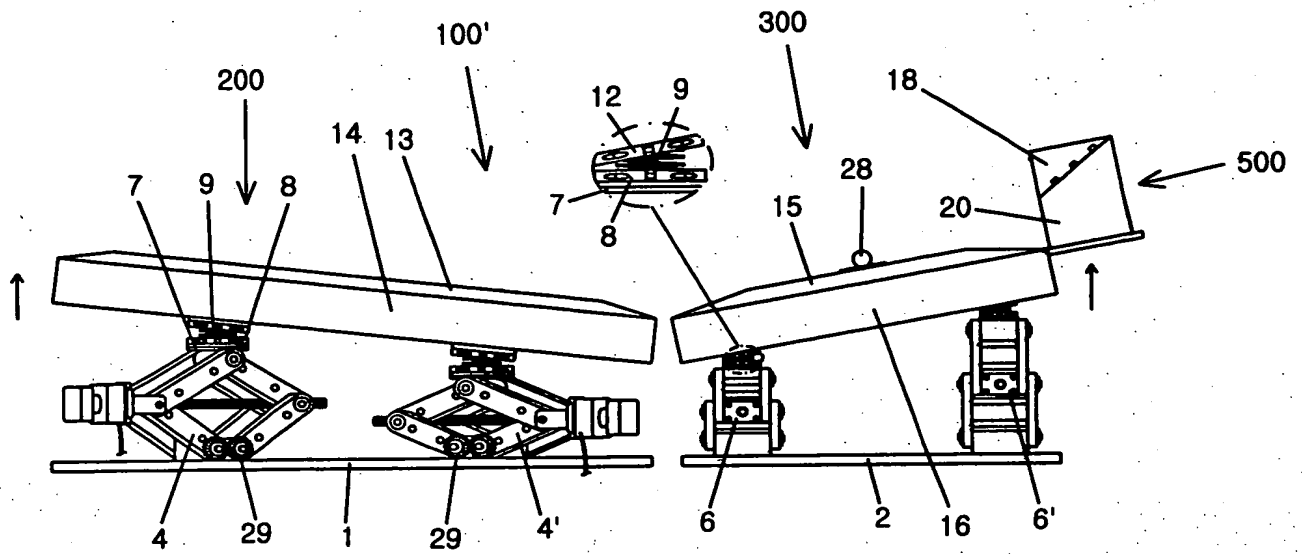


FIG.9b

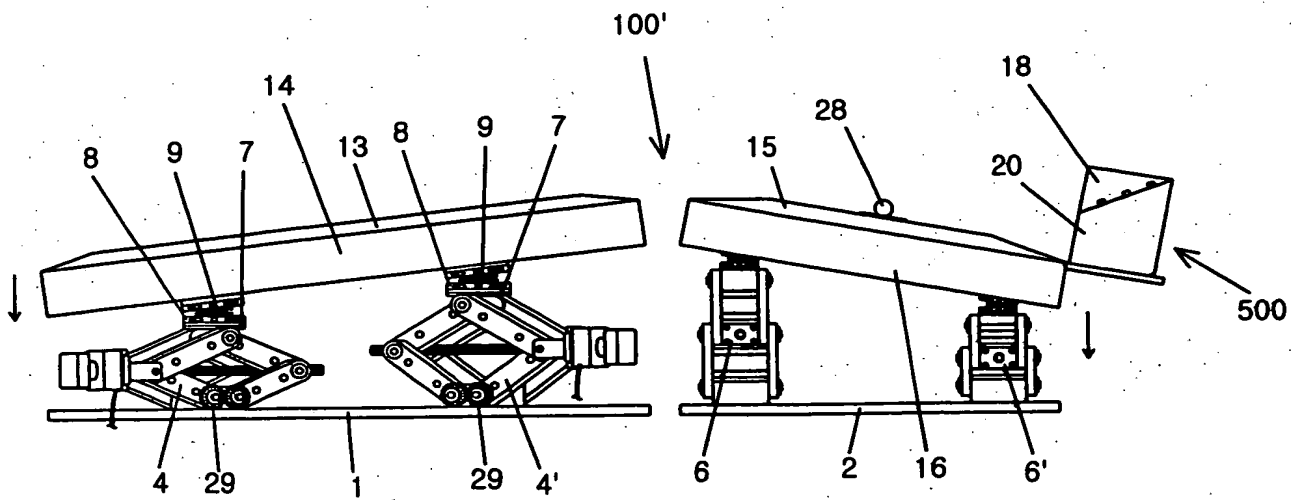


FIG.9c

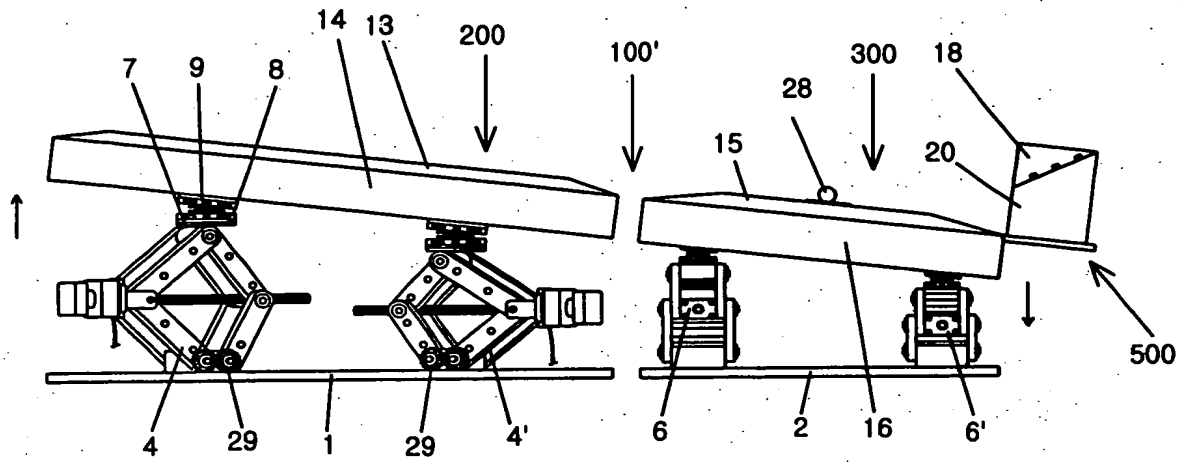


FIG.9d

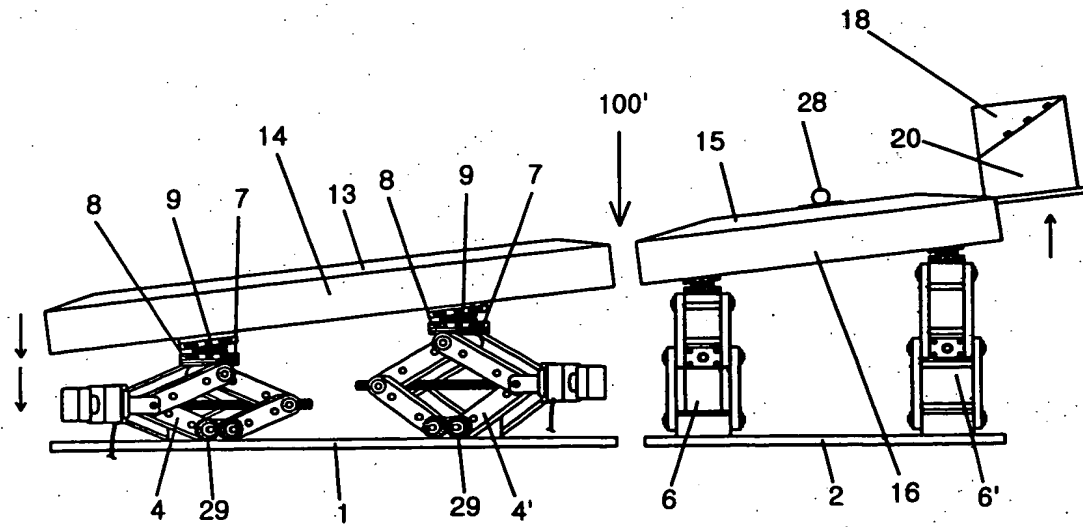


FIG.10a

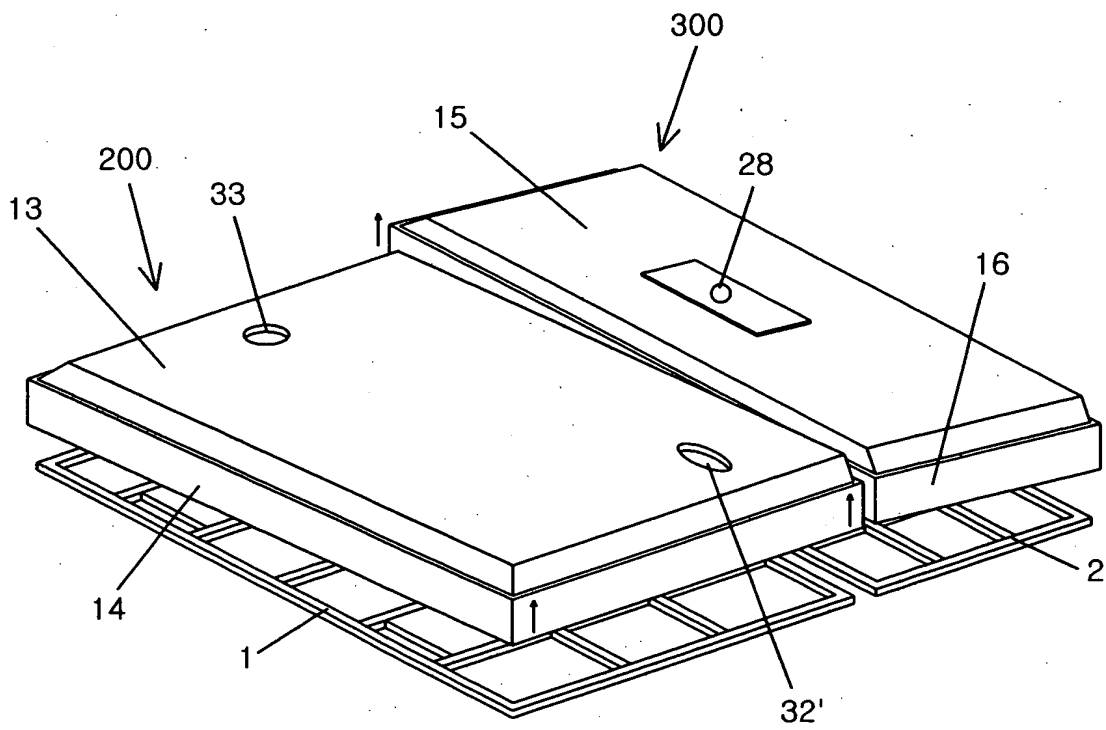


FIG.10b

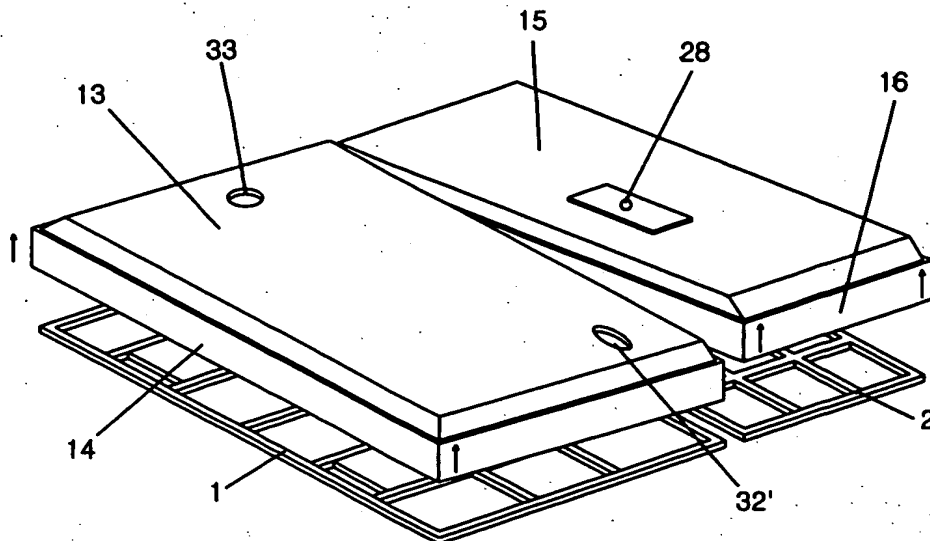


FIG.10c

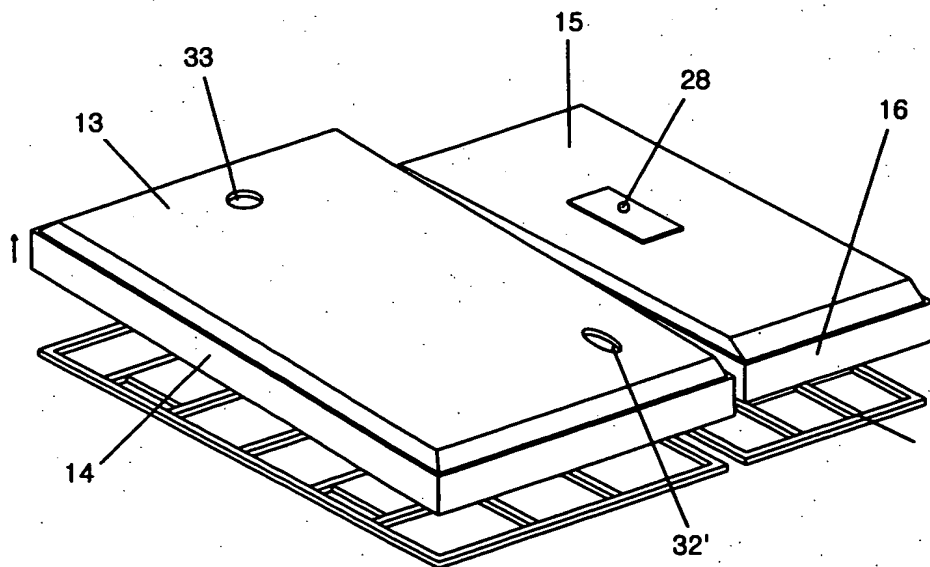


FIG.10d

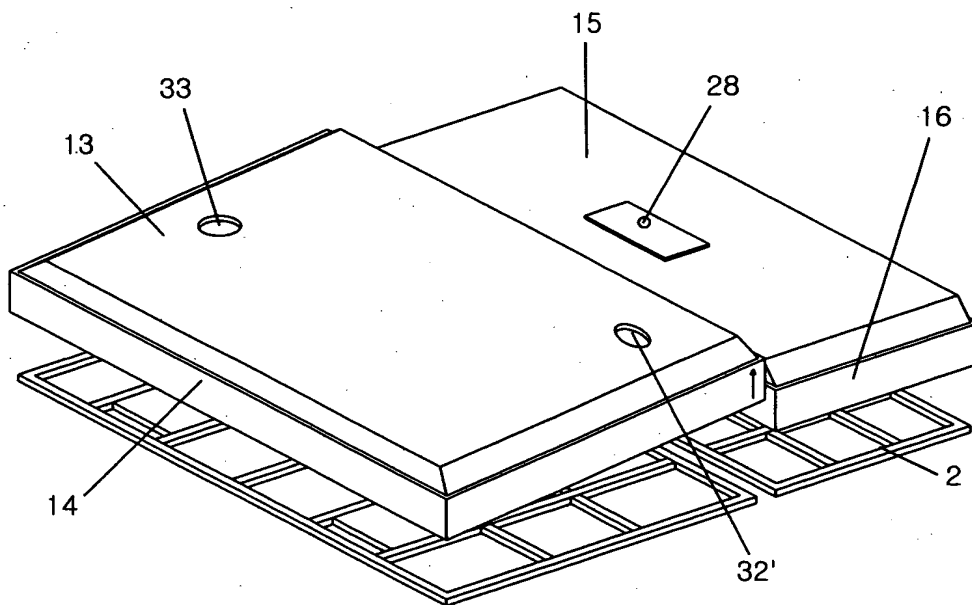


FIG.11

